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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









LOW POWER LOW OFFSET VOLTAGE QUAD COMPARATORS

Description

The AS339/339A consist of four independent precision voltage comparators with a typical offset voltage of 2.0mV and high gain. They are specifically designed to operate from a single power supply over wide range of voltages. Operation from split power supply is also possible and the low power supply current drain is independent of the magnitude of the power supply voltage.

The AS339/339A series are compatible with industry standard 339. The AS339A has more stringent input offset voltage than the AS339.

The AS339 is available in DIP-14, SOIC-14 and TSSOP-14 packages, and the AS339A is available in SOIC-14 package.

Features

- Wide Supply Voltage Range
 - Single Supply: 2.0V to 36V
 - Dual Supplies: ±1.0V to ±18V
- Low Supply Current Drain: 0.9mA
- Low Input Bias Current: 25nA (Typical)
- Low Input Offset Current: ±5.0nA (Typical)
- Low Input Offset Voltage: 2.0mV (Typical)
- Input Common Mode Voltage Range Includes Ground
- Differential Input Voltage Range Equals to the Power Supply Voltage
- Low Output Saturation Voltage: 200mV at 4mA
- Open Collector Output

Applications

- Battery Charger
- Cordless Telephone
- Switching Power Supply
- DC-DC Module
- PC Motherboard
- Communication Equipment

Pin Assignments

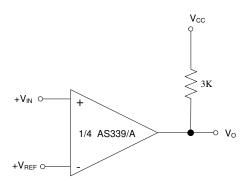
(Top View) (Top View) **OUTPUT 3 OUTPUT 2 OUTPUT 2** 14 14 **OUTPUT 3** OUTPUT 1 13 **OUTPUT 4 OUTPUT 1** 13 **OUTPUT 4** 3 12 **GND** 12 **GND** INPUT 1-11 INPUT 4+ INPUT 1-4 11 INPUT 4+ 10 INPUT 4-INPUT 1+ 5 INPUT 4-INPUT 1+ 10 INPUT 2-6 INPUT 3+ INPUT 2-9 INPUT 3+ INPUT 2+ 8 INPUT 3-INPUT 2+ INPUT 3-

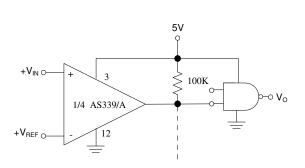
(SOIC-14/ M Package / TSSOP-14/ G Package)

(DIP-14/ P Package)

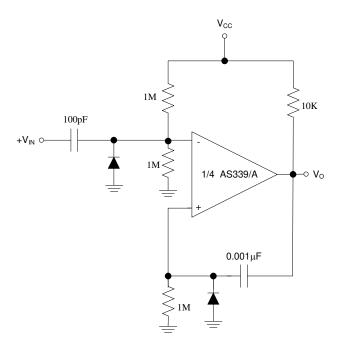


Typical Applications Circuit

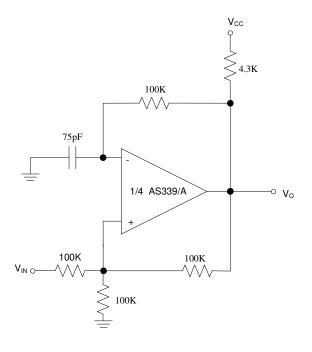




Basic Comparator



Driving CMOS

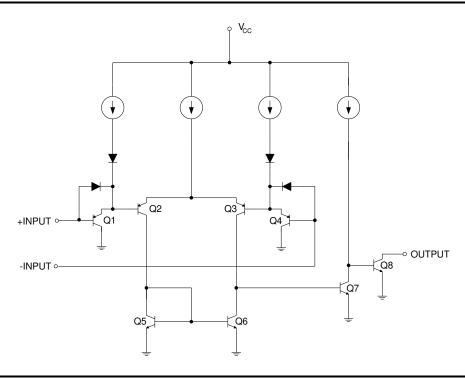


One Shot Multivibrator

Squarewave Oscillator



Functional Block Diagram



Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Ratin	Unit	
V _{CC}	Supply Voltage	40		٧
V_{ID}	Differential Input Voltage	40		٧
V _{IN}	Input Voltage	Input Voltage -0.3 to 40		V
I _{IN}	Input Current (V _{IN} < -0.3V) (Note 2)	50		mA
-	Output Short-Circuit to Ground	Continuous		-
		DIP-14	1050	
P_{D}	Power Dissipation (T _A = +25°C)	SOIC-14	890	mW
		TSSOP-14	790	
TJ	Operating Junction Temperature	+150		°C
T _{STG}	Storage Temperature Range	-65 to +150		°C
T _{LEAD}	Lead Temperature (Soldering, 10 Seconds)	+260		°C

Notes:

- 1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.
- 2. This input current will only exist when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistors becoming forward biased and thereby acting as input diode clamps. In addition to this diode action, there is also lateral NPN parasitic transistor action on the IC chip. This transistor action can cause the output voltages of the comparators to go to the V+ voltage level (or to ground for a large overdrive) for the time duration that an input is driven negative. This is not destructive and normal output states will re-establish when the input voltage, which was negative, again returns to a value greater than -0.3 V_{DC} (at +25°C).





Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{CC}	Supply Voltage	2	36	V
T _A	Operating Temperature Range	-40	+85	°C

Electrical Characteristics (Limits in standard typeface are for $T_A = +25^{\circ}C$, **bold** typeface applies over $T_A = -40^{\circ}C$ to $+85^{\circ}C$ (Note 3), $V_{CC} = 5V$, GND = 0V, unless otherwise specified.)

Parameter	Conditions		Min	Тур	Max	Unit
	$V_O = 1.4V$, $R_S = 0\Omega$, V_{CC} from 5V to 30V	40000	-	2	5	mV
land Official Vallages		AS339	-	_	7	
Input Offset Voltage		AS339A	-	2	3	
			_	_	5	
Input Piga Current	$I_{\text{IN}}+$ or $I_{\text{IN}}-$ with output in Linear Range, $V_{\text{CM}}=0V$		_	25	250	nA
Input Bias Current			_	_	400	
land to Office to Course at	L. L. W. OV		_	5.0	50	nA
Input Offset Current	IIN+ - IIN-, VCM = UV	I_{IN} + - I_{IN} -, $V_{CM} = 0V$		_	200	
Input Common Mode Voltage Range (Note 4)	V _{CC} = 30V		0	-	V _{CC} -1.5	V
	R _L = ∞	V _{CC} = 5V	-	0.9	2.0	mA
Committee Committee			_	_	3.0	
Supply Current		V _{CC} = 30V	-	1.2	2.5	
			-	_	3.5	
Voltage Gain	$R_L \ge 15k\Omega$, $V_{CC} = 15V$, $V_O = 1V$ to 11V		50	200	_	V/mV
Large Signal Response Time	V_{IN} = TTL Logic Swing, V_{REF} = 1.4V V_{RL} = 5V, R_L = 5.1k Ω		_	200	_	ns
Response Time	$V_{RL} = 5V, R_L = 5.1k\Omega$		_	1.3	_	μs
Output Sink Current	$V_{IN^-} = 1V$, $V_{IN} + = 0$, $V_O = 1.5V$		6.0	16	_	mA
Output Lookage Current	V_{IN} = 0V, V_{IN} + = 1V, V_O = 5V		-	0.1	-	nA
Output Leakage Current	V _{IN} -= 0V, V _{IN} += 1V, V _O = 30V		-	_	1	μΑ
Oak walkan Malkana	V _{IN} -= 1V, V _{IN} += 0, I _{SINK} ≤ 4mA		-	200	400	mV
Saturation Voltage			-	_	500	
Thermal Resistance (Junction to	SOIC-14		-	51.93	_	°C/W
Case)	DIP-14			35.00	-	

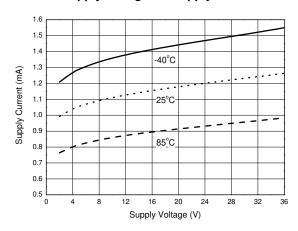
Notes: 3. Limits over the full temperature are guaranteed by design, but not tested in production.

^{4.} The input common-mode voltage of either input signal voltage should not be allowed to go negatively by more than 0.3V (at +25°C). The upper end of the common-mode voltage range is V_{CC} -1.5V (at +25°C), but either or both inputs can go to +36V without damages, independent of the magnitude of the V_{CC}.

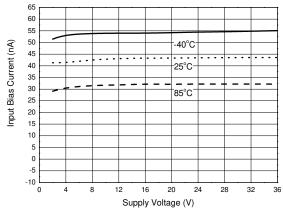


Performance Characteristics

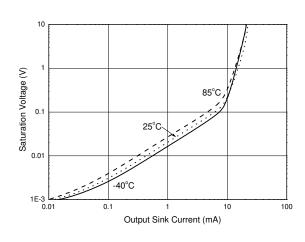
Supply Voltage vs. Supply Current



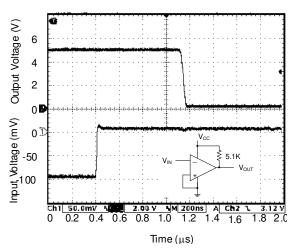
Supply Voltage vs. Input Bias Current



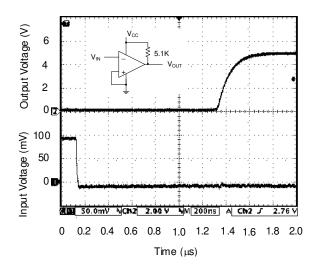
Output Sink Current vs. Saturation Voltage



Response Time for 5mV Input Overdrive - Negative Transition



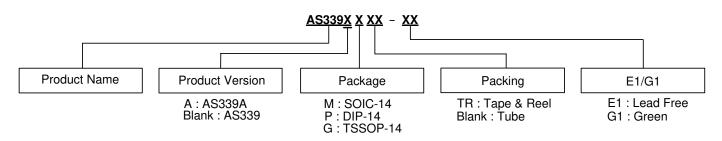
Response Time for 5mV Input Overdrive - Positive Transition







Ordering Information



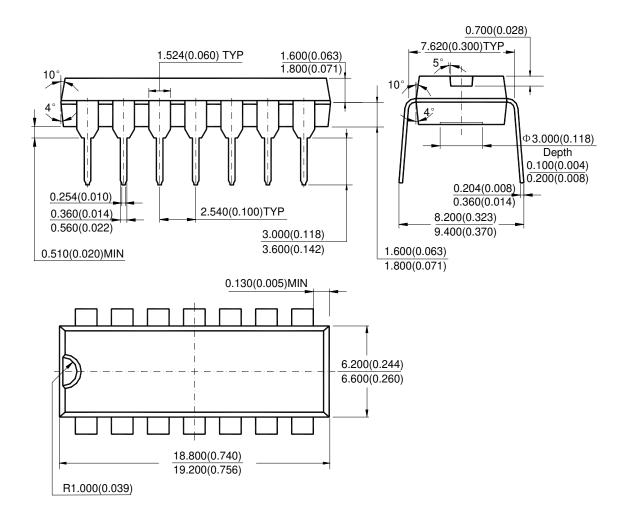
BCD Semiconductor's Pb-free products, as designated with "E1" suffix in the part number, are RoHS compliant. Products with "G1" suffix are available in green packages.

Package	Temperature Range	Part Number		Marking ID		
		Lead Free	Green	Lead Free	Green	Packing Type
SOIC-14	-40°C to +85°C	AS339M-E1	AS339M-G1	AS339M-E1	AS339M-G1	Tube
		AS339MTR-E1	AS339MTR-G1	AS339M-E1	AS339M-G1	Tape & Reel
		AS339AM-E1	AS339AM-G1	AS339AM-E1	AS339AM-G1	Tube
		AS339AMTR-E1	AS339AMTR-G1	AS339AM-E1	AS339AM-G1	Tape & Reel
DIP-14		AS339P-E1	AS339P-G1	AS339P-E1	AS339P-G1	Tube
TSSOP-14		AS339GTR-E1	AS339GTR-G1	EGS339	GGS339	Tape & Reel



Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: DIP-14

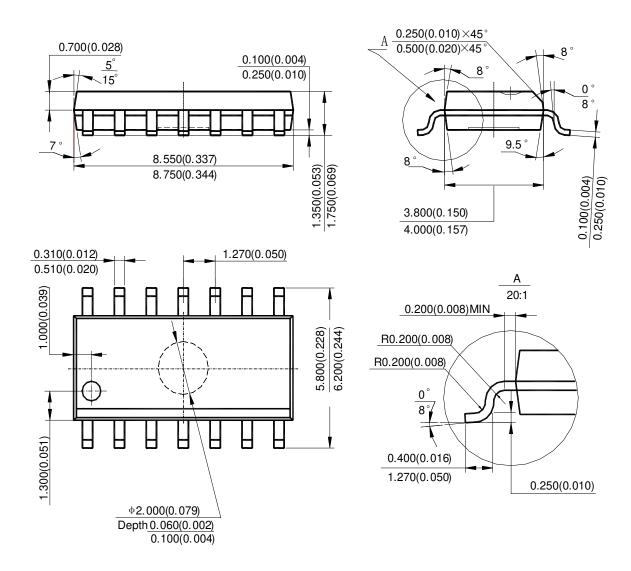


Note: Eject hole, oriented hole and mold mark is optional.



Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(2) Package Type: SOIC-14

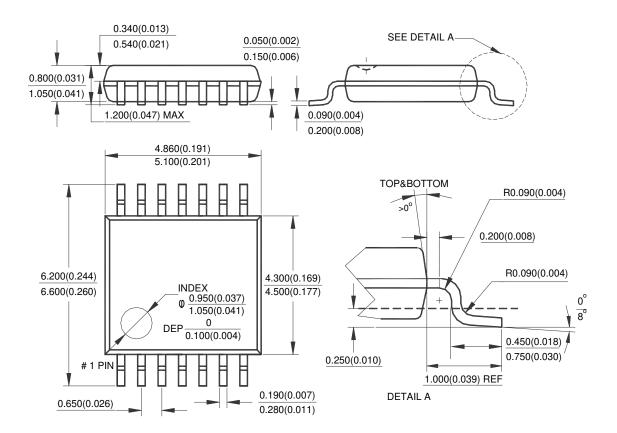


Note: Eject hole, oriented hole and mold mark is optional.



Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(3) Package Type: TSSOP-14

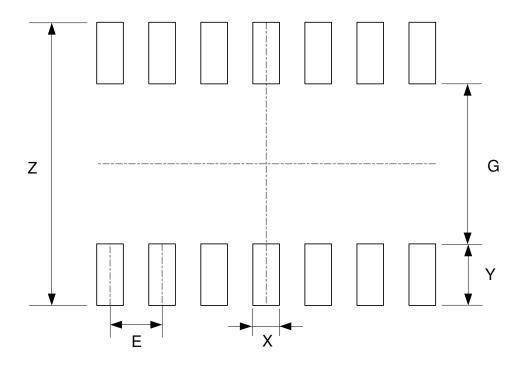


Note: Eject hole, oriented hole and mold mark is optional.



Suggested Pad Layout

(1) Package Type: SOIC-14

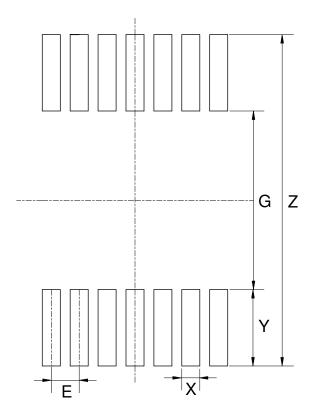


Dimensions	Z	G	X	Y	E
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050



Suggested Pad Layout (Cont.)

(2) Package Type: TSSOP-14



Dimensions	Z	G	X	Y	E
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	7.720/0.304	4.160/0.164	0.420/0.017	1.780/0.070	0.650/0.026





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